TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7SZ32F, TC7SZ32FU

2-Input OR Gate

Features

High output current : ±24 mA (min) at V_{CC} = 3 V

• Super high speed operation: tpd=2.4 ns (typ.)

at V_{CC} = 5 V, 50 pF

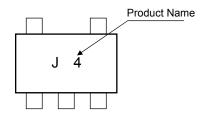
• Operating voltage range : V_{CC} = 1.8 to 5.5 V

• 5.5-V tolerant inputs

• 5.5-V power down protection output

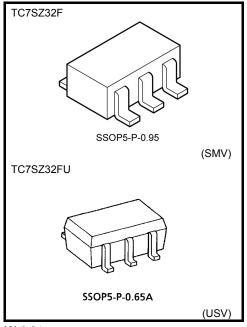
 Matches the performance of TC74LCX series when operated at 2.2 VV/ce

Marking



Absolute Maximum Ratings (Ta = 25°C)

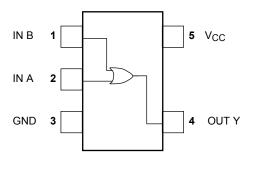
| Characteristics | Symbol | Rating | Unit |
|------------------------------------|------------------|---------------------------------------|--------|
| Supply voltage | V _{CC} | −0.5 to 6 | V |
| DC input voltage | V _{IN} | -0.5 to 6 | V |
| DC output voltage | V _{OUT} | -0.5 to 6 (Note 1) | \ \ |
| DC output voltage | | -0.5 to V _{CC} +0.5 (Note 2) | ľ |
| Input diode current | I _{IK} | -20 | mA |
| Output diode current | lok | -20 (Note 3) | mA |
| DC output current | lout | ±50 | mA |
| DC V _{CC} /ground current | Icc | ±50 | mA |
| Power dissipation | PD | 200 | mW |
| Storage temperature | T _{stg} | -65 to 150 | °C |
| Lead temperature (10 s) | TL | 260 | °C |



Weight:

SSOP5-P-0.95 : 0.016 g (typ.) SSOP5-P-0.65A : 0.006 g (typ.)

Pin Assignment (top view)



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: $V_{CC} = 0 V$

Note 2: High or Low State. Do not exceed I_{OUT} of absolute maximum ratings.

Note 3: V_{OUT} < GND



IEC Logic Symbol



Truth Table

| Α | В | Y |
|---|---|---|
| L | L | L |
| L | Н | Н |
| Н | L | Н |
| Н | Н | Н |

Operating Ranges

| Characteristics | Symbol | Rating | Unit | |
|--------------------------|------------------|--|------|--|
| Supply voltage | V _{CC} | 1.8 to 5.5 | V | |
| Supply voltage | | 1.5 to 5.5 (Note 4) | V | |
| Input voltage | V _{IN} | 0 to 5.5 | V | |
| Output voltage | V _{OUT} | 0 to 5.5 (Note 5) | > | |
| | | 0 to V _{CC} (Note 6) | | |
| Operating temperature | T _{opr} | −40 to 85 | °C | |
| | dt/dv | 0 to 20 (V _{CC} = 1.8 V, 2.5 V \pm 0.2 V) | | |
| Input rise and fall time | | 0 to 10 (V _{CC} = 3.3 V \pm 0.3 V) | ns/V | |
| | | 0 to 5 (V _{CC} = 5.0 V \pm 0.5 V) | | |

2

Note 4: Data retention only

Note 5: $V_{CC} = 0 V$

Note 6: High or Low state

Electrical Characteristics

DC Characteristics

| Characteristics Symbol Test Co | | Condition | Condition | | Ta = 25°C | | | Ta = -40 to 85°C | | |
|--|------------------|---|--------------------------------|---------------------|---------------------------|------------------------|------------------------|---------------------------|---------------------------------------|------|
| | | 1650 | Condition | V _{CC} (V) | Min | Тур. | Max | Min | Max | Unit |
| High-level input voltage V _{IH} | | | | | V _{CC} × 0.88 | _ | _ | V _{CC} × 0.88 | | · v |
| | | _ | | 2.3 to 5.5 | V _{CC} × 0.75 | _ | _ | V _{CC} × 0.75 | _ | |
| | | | 1.8 | _ | _ | V _{CC} × 0.12 | _ | V _{CC} × 0.12 | \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | |
| Low-level input voltage | V _{IL} | | _ | 2.3 to 5.5 | _ | _ | V _{CC} × 0.25 | _ | V _{CC} × 0.25 | V |
| | | | | 1.8 | 1.7 | 1.8 | | 1.7 | | |
| | | | I _{OH} = -100 μA | 2.3 | 2.2 | 2.3 | _ | 2.2 | | 1 |
| | | | ΙΟΗ = – 100 μΑ | 3.0 | 2.9 | 3.0 | _ | 2.9 | | |
| High-level output | V | V _{IN} = V _{IH} | | 4.5 | 4.4 | 4.5 | _ | 4.4 | _ | |
| voltage | V _{OH} | or V _{IL} | I _{OH} = -8 mA | 2.3 | 1.9 | 2.15 | _ | 1.9 | _ | V |
| | | | I _{OH} = -16 mA | 3.0 | 2.4 | 2.8 | _ | 2.4 | _ | |
| | | | I _{OH} = -24 mA | 3.0 | 2.3 | 2.68 | _ | 2.3 | _ | |
| | | | $I_{OH} = -32 \text{ mA}$ | 4.5 | 3.8 | 4.2 | _ | 3.8 | | |
| | | | I _{OL} = 100 μA | 1.8 | | 0 | 0.1 | _ | 0.1 | V |
| | | | | 2.3 | | 0 | 0.1 | _ | 0.1 | |
| | | $V_{IN} = V_{IL}$ | | 3.0 | | 0 | 0.1 | _ | 0.1 | |
| Low-level | V | | | 4.5 | _ | 0 | 0.1 | _ | 0.1 | |
| output voltage | V _{OL} | | I _{OL} = 8 mA | 2.3 | _ | 0.1 | 0.3 | _ | 0.3 | |
| | | | I _{OL} = 16 mA | 3.0 | _ | 0.15 | 0.4 | _ | 0.4 | |
| | | | I _{OL} = 24 mA | 3.0 | _ | 0.22 | 0.55 | _ | 0.55 | |
| | | | I _{OL} = 32 mA | 4.5 | _ | 0.22 | 0.55 | _ | 0.55 | |
| Input leakage current | I _{IN} | V _{IN} = 5.5 V | V _{IN} = 5.5 V or GND | | | _ | ±1 | _ | ±10 | μА |
| Power off leakage current | l _{OFF} | V _{IN} or V _{OUT} = 5.5 V | | 0.0 | _ | _ | 1 | _ | 10 | μА |
| Quiescent supply current | Icc | V _{IN} = V _{CC} or GND | | 5.5 | | | 2 | _ | 20 | μА |

3 2009-09-09

AC Characteristics (unless otherwise specified, Input: $t_r = t_f = 3$ ns)

| Characteristics S | Symbol | Test Condition | | $Ta = 25^{\circ}C$ $Ta = -40 \text{ to } 85^{\circ}C$ | | | | Unit | |
|-------------------------------|--------------------------------------|---|---------------------|---|------|------|-----|------|-------|
| | | | V _{CC} (V) | Min | Тур. | Max | Min | Max | Offic |
| Propagation delay time | ^t pLH t _{pHL} | C_L = 15 pF, R_L = 1 M Ω | 1.8 | 2.0 | 4.6 | 10.0 | 2.0 | 10.5 | - ns |
| | | | 2.5 ± 0.2 | 0.8 | 3.0 | 7.0 | 0.8 | 7.5 | |
| | | | 3.3 ± 0.3 | 0.5 | 2.4 | 4.7 | 0.5 | 5.0 | |
| | | | 5.0 ± 0.5 | 0.5 | 1.9 | 4.1 | 0.5 | 4.4 | |
| | | $C_L = 50 \text{ pF},$ $R_L = 500 \Omega$ | 3.3 ± 0.3 | 1.5 | 3.0 | 5.2 | 1.5 | 5.5 | |
| | | | 5.0 ± 0.5 | 0.8 | 2.4 | 4.5 | 0.8 | 4.8 | |
| Input capacitance | C _{IN} | _ | 0 to 5.5 | 1 | 4 | - | _ | | pF |
| Power dissipation capacitance | C _{PD} | (Note 7) | 3.3 | 1 | 20 | | _ | | - pF |
| | | | 5.5 | | 26 | | _ | | |

Note 7: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

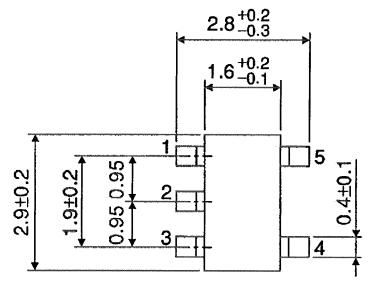
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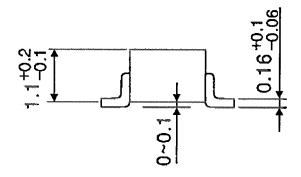
Average operating current can be obtained by the equation:

 $I_{CC (opr.)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

Package Dimensions

SSOP5-P-0.95 Unit: mm



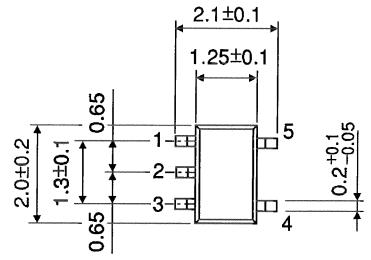


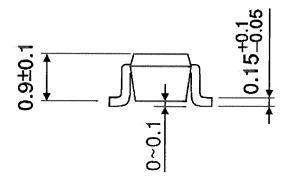
Weight: 0.016 g (typ.)

5 2009-09-09

Package Dimensions

SSOP5-P-0.65A Unit: mm





Weight: 0.006 g (typ.)

6 2009-09-09

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